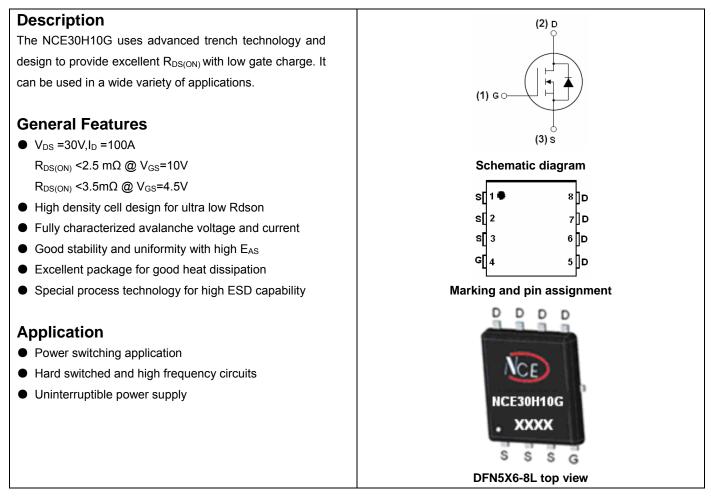




NCE N-Channel Enhancement Mode Power MOSFET



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE30H10G	NCE30H10G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	30	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	Ι _D	100	А
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	70.7	А
Pulsed Drain Current	I _{DM}	300	Α
Maximum Power Dissipation	PD	65	W
Derating factor		0.43	W/℃
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C







Thermal Characteristic

Electrical Characteristics (T_c=25 $^\circ\!\mathrm{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30	35	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.2	1.7	2.5	V
Drain-Source On-State Resistance		V _{GS} =10V, I _D =20A	-	1.9	2.5	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =10A		2.9	3.5	mΩ
Forward Transconductance	G FS	V _{DS} =10V,I _D =20A	32	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	5000	-	PF
Output Capacitance	C _{oss}	V _{DS} =15V,V _{GS} =0V,	-	1135	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz - 563 -		-	PF	
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	26	-	nS
Turn-on Rise Time	tr	V_{DD} =15V, R _L =15 Ω	-	24	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =2.5Ω	-	91	-	nS
Turn-Off Fall Time	t _f		-	39	-	nS
Total Gate Charge	Qg		-	38		nC
Gate-Source Charge	Q _{gs}	V _{DS} =15V,I _D =20A, V _{GS} =10V	-	9		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	13		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	100	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 20A	-	42	_	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	39	_	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negl	igible (turi	n-on is do	ominated b	y LS+LD)

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, t \leq 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production



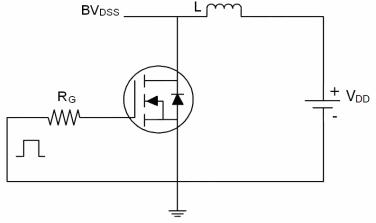
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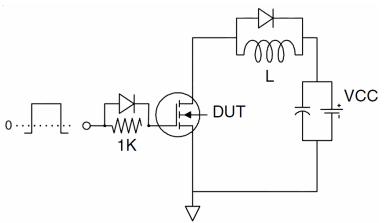
NCE30H10G

Test circuit

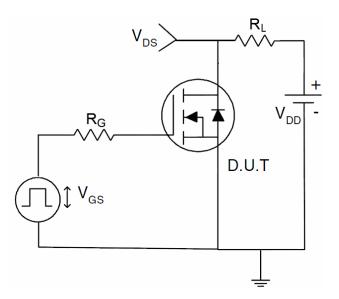
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



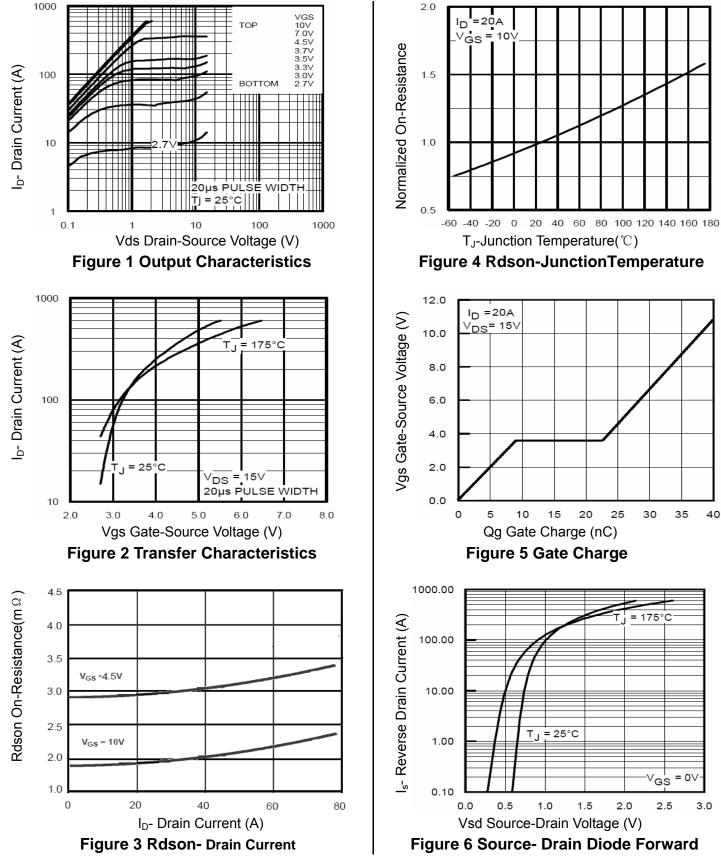
3) Switch Time Test Circuit





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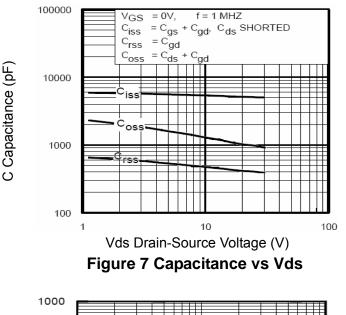




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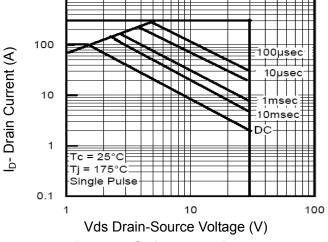


Figure 8 Safe Operation Area

BV_{DSS} (norm) 1.21.11.00.90.8-50 0 50 100 TJ(*C) TJ-Junction Temperature(°C)

Figure 9 BV_{DSS} vs Junction Temperature

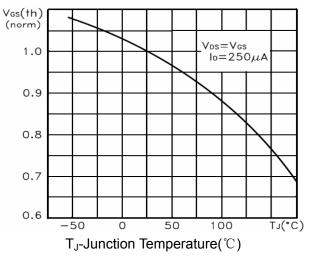


Figure 10 V_{GS(th)} vs Junction Temperature

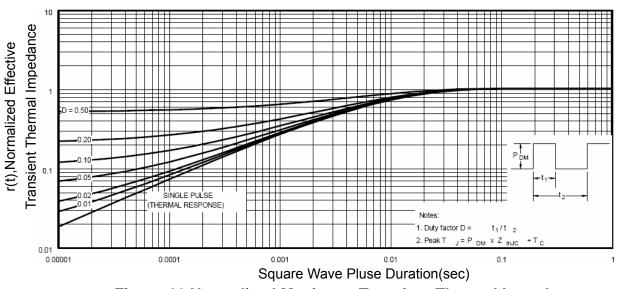


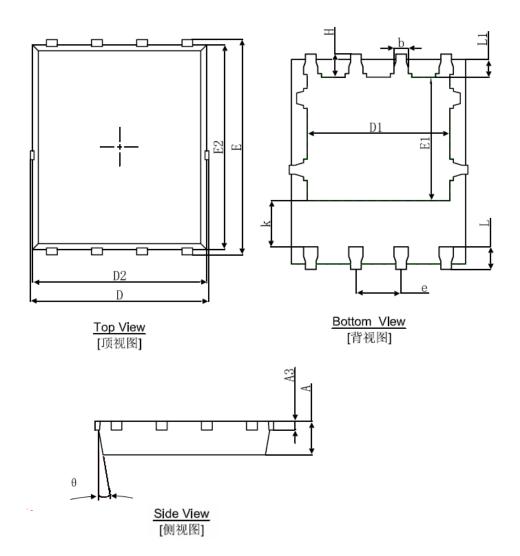
Figure 11 Normalized Maximum Transient Thermal Impedance





NCE30H10G

DFN5X6-8L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	0.900	1.000	0.035	0.039	
A3	0.254REF.		0.010REF.		
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
е	1.270TYP.		0.050TYP.		
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	







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